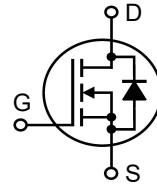


High Voltage Power MOSFETs

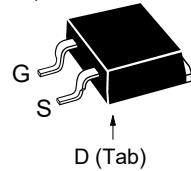
IXTA4N150HV IXTT4N150HV

V_{DSS} = 1500V
 I_{D25} = 4A
 $R_{DS(on)}$ ≤ 6Ω

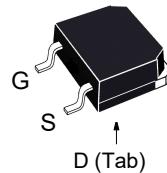


N-Channel Enhancement Mode
Fast Intrinsic Diode

TO-263HV



TO-268HV



G = Gate D = Drain
 S = Source Tab = Drain

Symbol	Test Conditions	Maximum Ratings		
V_{DSS}	T_J = 25°C to 150°C	1500		V
V_{DGR}	T_J = 25°C to 150°C, $R_{GS} = 1M\Omega$	1500		V
V_{GSS}	Continuous	±30		V
V_{GSM}	Transient	±40		V
I_{D25}	T_c = 25°C	4		A
I_{DM}	T_c = 25°C, Pulse Width Limited by T_{JM}	12		A
I_A	T_c = 25°C	4		A
E_{AS}	T_c = 25°C	350		mJ
dv/dt	$I_s \leq I_{DM}$, $V_{DD} \leq V_{DSS}$, $T_J \leq 150^\circ C$	5		V/ns
P_D	T_c = 25°C	280		W
T_J		- 55 ... +150		°C
T_{JM}		150		°C
T_{stg}		- 55 ... +150		°C
T_{SOLD}	Plastic Body for 10s	260		°C
Weight	TO-263	2.5		g
	TO-268	4.0		g

Features

- High Blocking Voltage
- High Voltage Package
- Fast Intrinsic Diode
- Low Package Inductance

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
BV_{DSS}	$V_{GS} = 0V$, $I_D = 250\mu A$	1500		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	2.5	5.0	V
I_{GSS}	$V_{GS} = \pm 30V$, $V_{DS} = 0V$			± 100 nA
I_{DSS}	$V_{DS} = V_{DSS}$, $V_{GS} = 0V$ $T_J = 125^\circ C$			10 μA 100 μA
$R_{DS(on)}$	$V_{GS} = 10V$, $I_D = 0.5 \cdot I_{D25}$, Note 1		6	Ω

Applications

- High Voltage Power Supplies
- Capacitor Discharge
- Pulse Circuits

IXTA4N150HV
IXTT4N150HV

Symbol	Test Conditions (T _J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
g_{fs}	V _{DS} = 20V, I _D = 0.5 • I _{D25} , Note 1	2.8	4.6	S
C_{iss}	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz	1576	pF	
C_{oss}		105	pF	
C_{rss}		35	pF	
t_{d(on)}	Resistive Switching Times V _{GS} = 10V, V _{DS} = 0.5 • V _{DSS} , I _D = 0.5 • I _{D25} R _G = 5Ω (External)	19	ns	
t_r		23	ns	
t_{d(off)}		42	ns	
t_f		22	ns	
Q_{g(on)}	V _{GS} = 10V, V _{DS} = 0.5 • V _{DSS} , I _D = 0.5 • I _{D25}	44.5	nC	
Q_{gs}		7.7	nC	
Q_{gd}		21.7	nC	
R_{thJC}			0.45	°C/W

Source-Drain Diode

Symbol	Test Conditions (T _J = 25°C, Unless Otherwise Specified)	Characteristic Values		
		Min.	Typ.	Max.
I_s	V _{GS} = 0V		4	A
I_{SM}	Repetitive, Pulse Width Limited by T _{JM}		16	A
V_{SD}	I _F = I _S , V _{GS} = 0V, Note 1		1.3	V
t_{rr}	I _F = 2A, -di/dt = 100A/μs V _R = 100V, V _{GS} = 0V	0.9	μs	
I_{RM}		15.0	A	
Q_{RM}		6.7	μC	

Note 1. Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

Littelfuse reserves the right to change limits, test conditions, and dimensions.

LF MOSFETs and IGBTs are covered
by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338 B2
4,860,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2
4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

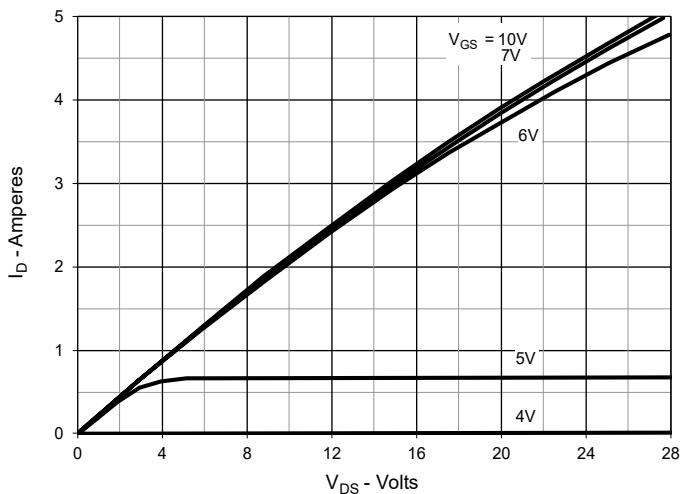
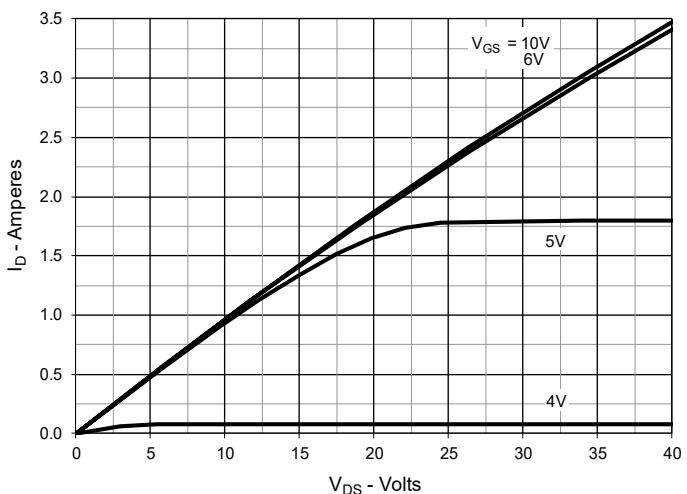
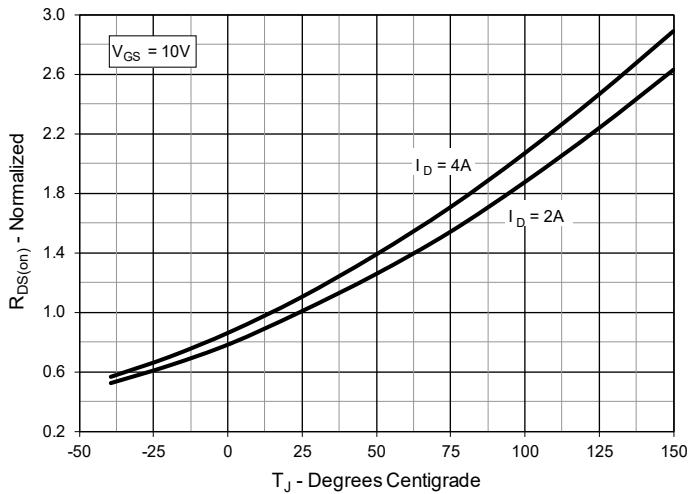
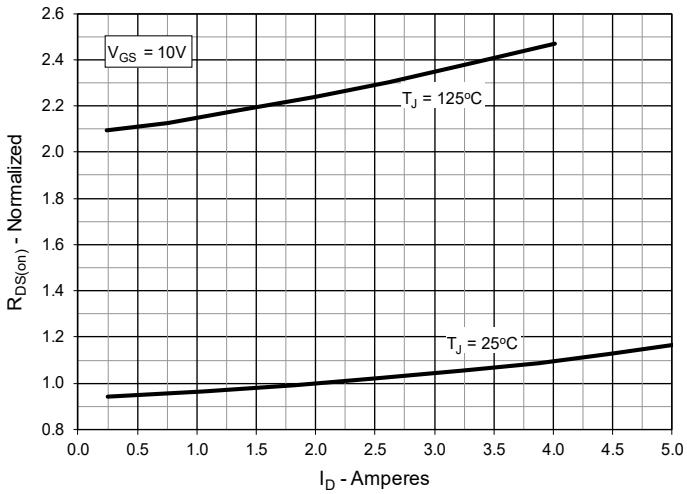
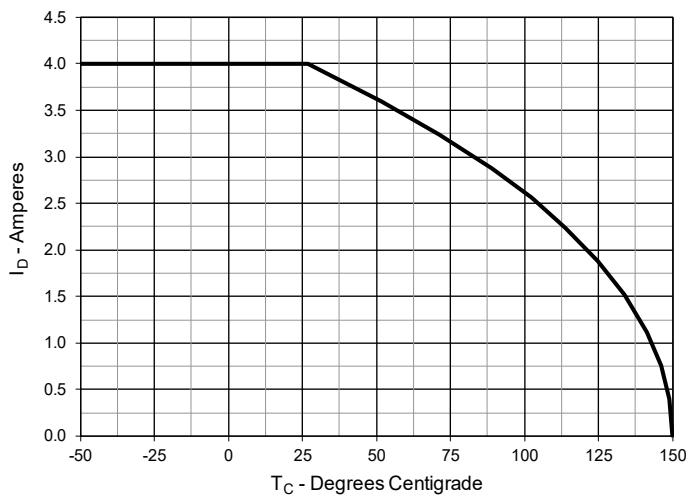
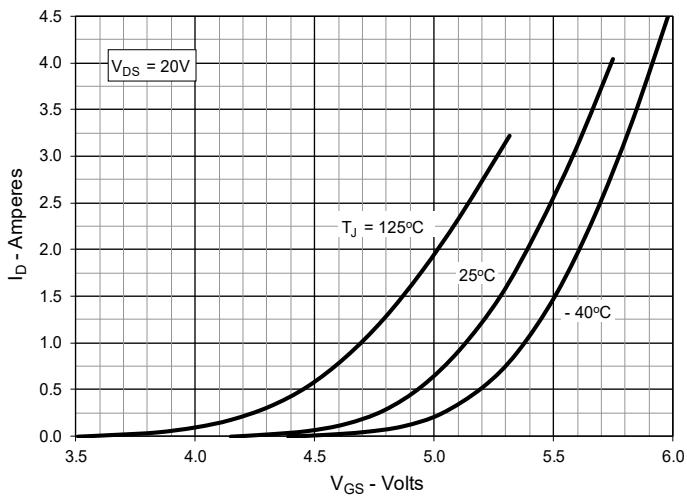
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 2. Output Characteristics @ $T_J = 125^\circ\text{C}$

Fig. 3. $R_{DS(on)}$ Normalized to $I_D = 2\text{A}$ Value vs. Junction Temperature

Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 2\text{A}$ Value vs. Drain Current

Fig. 5. Maximum Drain Current vs. Case Temperature

Fig. 6. Input Admittance


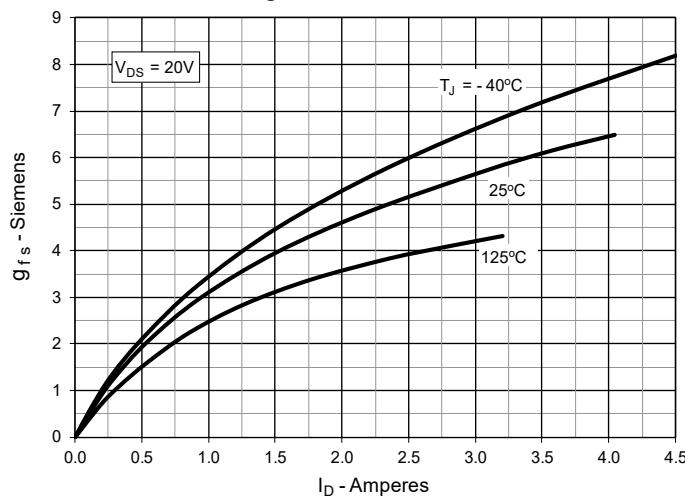
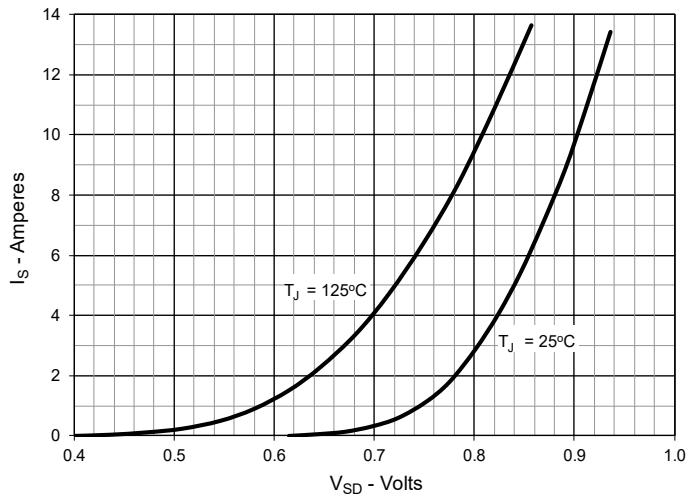
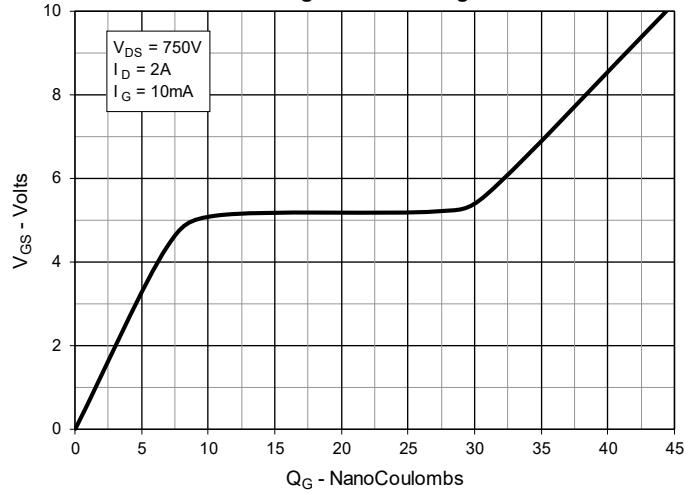
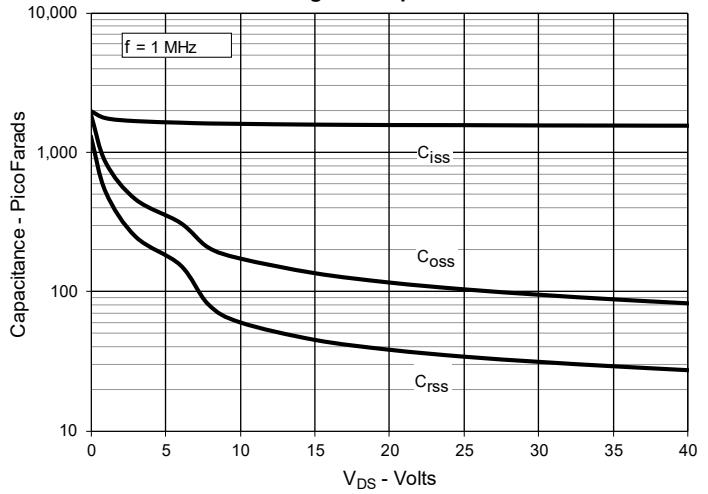
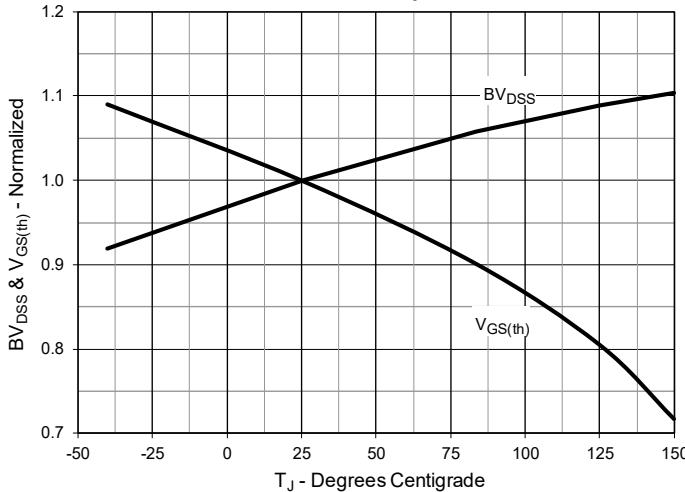
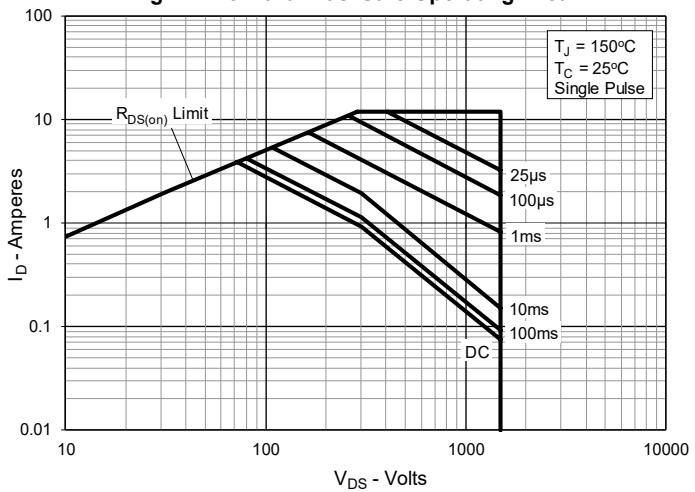
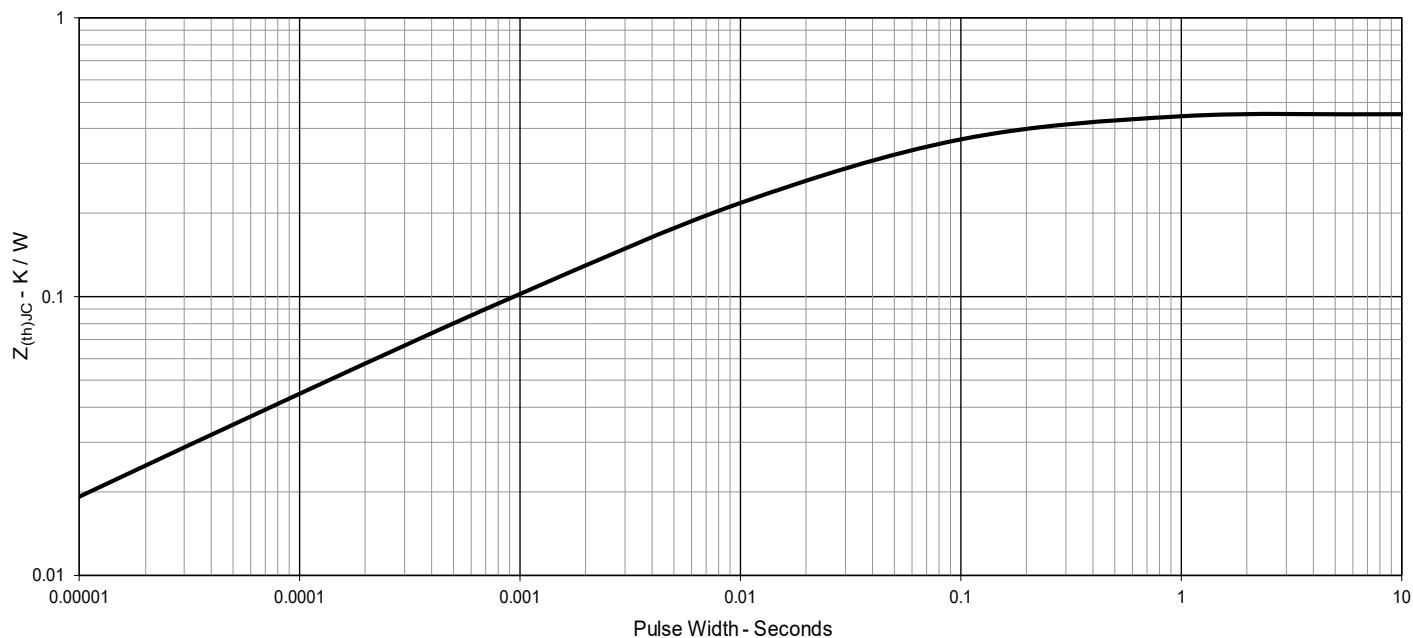
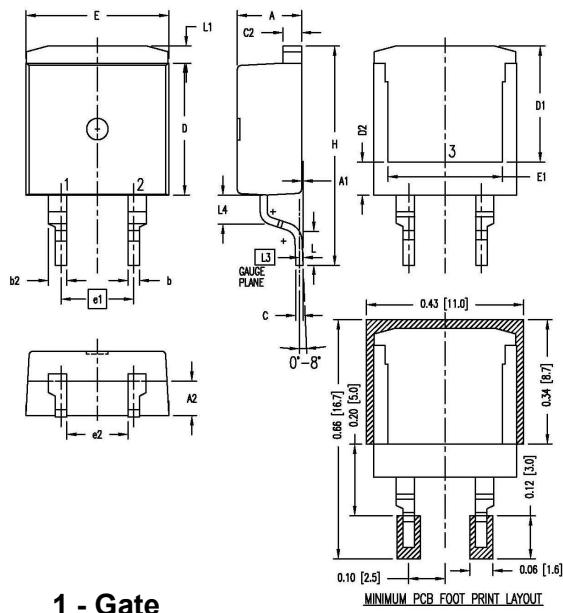
Fig. 7. Transconductance

Fig. 8. Forward Voltage Drop of Intrinsic Diode

Fig. 9. Gate Charge

Fig. 10. Capacitance

Fig. 11. Breakdown and Threshold Voltages vs. Junction Temperature

Fig. 12. Forward-Bias Safe Operating Area


Fig. 13. Maximum Transient Thermal Impedance



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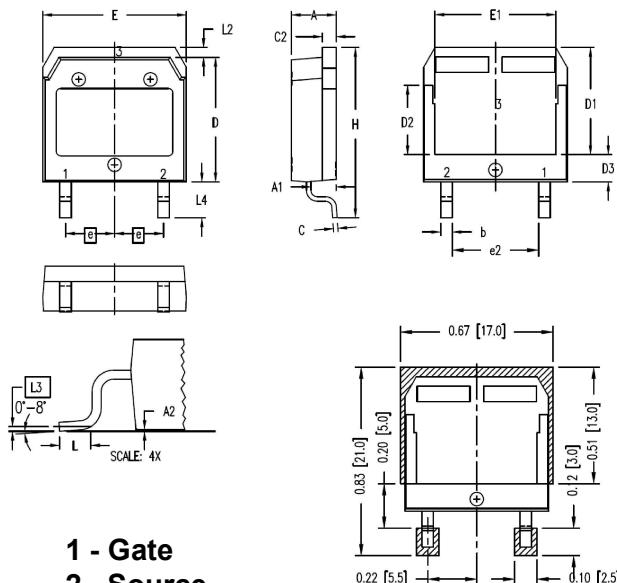
TO-263HV Outline



1 - Gate
2 - Source
3 - Drain

SYM	Inches		Millimeters	
	MIN	MAX	MIN	MAX
A	0.170	0.185	4.30	4.70
A1	0.000	0.008	0.00	0.20
A2	0.091	0.098	2.30	2.50
b	0.028	0.035	0.70	0.90
b2	0.046	0.054	1.18	1.38
c	0.018	0.024	0.45	0.60
C2	0.049	0.055	1.25	1.40
D	0.354	0.370	9.00	9.40
D1	0.311	0.327	7.90	8.30
D2	0.083	0.098	2.10	2.50
E	0.386	0.402	9.80	10.20
E1	0.307	0.323	7.80	8.20
e1	0.200	BSC	5.08	BSC
e (2)	0.163	0.174	4.13	4.43
H	0.591	0.614	15.00	15.60
L	0.079	0.102	2.00	2.60
L1	0.039	0.055	1.00	1.40
L3	0.100	BSC	0.254	BSC
L4	0.071	0.087	1.80	2.20

TO-268HV Outline



1 - Gate
2 - Source
3 - Drain

SYM	Inches		Millimeters	
	MIN	MAX	MIN	MAX
A	0.193	0.201	4.90	5.10
A1	0.106	0.114	2.70	2.90
A2	0.001	0.010	0.02	0.25
b	0.045	0.057	1.15	1.45
C	0.016	0.026	0.40	0.65
C2	0.057	0.063	1.45	1.60
D	0.543	0.551	13.80	14.00
D1	0.465	0.476	11.80	12.10
D2	0.295	0.307	7.50	7.80
D3	0.114	0.126	2.90	3.20
E	0.624	0.632	15.85	16.05
E1	0.524	0.535	13.30	13.60
e	0.215	BSC	5.45	BSC
e (2)	0.374	0.386	9.50	9.80
H	0.736	0.752	18.70	19.10
L	0.067	0.079	1.70	2.00
L2	0.039	0.045	1.00	1.15
L3	0.010	BSC	0.25	BSC
L4	0.150	0.161	3.80	4.10